

General Description

This IGBT is produced using advanced Magnachip's Field Stop Trench IGBT Technology, which provides low $V_{CE(SAT)}$, high switching performance and excellent quality.

This device is for PFC, UPS & Inverter applications.

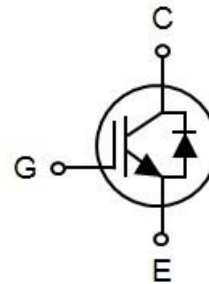
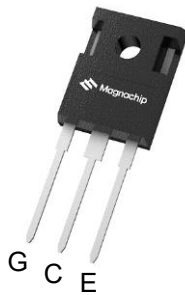
Applications

- PFC
- UPS
- Inverter

Features

- High Speed Switching & Low Power Loss
- $V_{CE(sat)} = 2.0V @ I_c = 40A$
- High Input Impedance
- $t_{rr} = 100ns$ (typ.)
- Ultra Soft, fast recovery anti-parallel diode
- Ultra narrowed VF distribution control
- Positive Temperature coefficient for easy paralleling

TO-247



Absolute Maximum Ratings

Characteristics		Symbol	Rating	Unit
Collector-emitter voltage		V_{CES}	1200	V
Gate-emitter voltage		V_{GES}	± 20	V
Collector current	$T_C = 25^\circ C$	I_c	80	A
	$T_C = 100^\circ C$		40	A
Pulsed collector current, pulse time limited by T_{jmax}		I_{CM}	160	A
Diode forward current @ $T_C = 100^\circ C$		I_F	40	A
Diode pulsed current, Pulse time limited by T_{jmax}		I_{FM}	160	A
Power dissipation	$T_C = 25^\circ C$	P_D	357	W
	$T_C = 100^\circ C$		142	W
Short circuit withstand time $V_{CE} = 600V, V_{GE} = 15V, T_C = 150^\circ C$		tsc	10	μs
Operating Junction and storage temperature range		T_J, T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	$^\circ C/W$
Thermal resistance junction-to-case for IGBT	$R_{\theta JC}$	0.35	
Thermal resistance junction-to-case for Diode	$R_{\theta JC}$	0.8	

Ordering Information

Part Number	Marking	Temp. Range	Package	Packing	RoHS Status
MBQ40T120FESTH	40T120FES	-55~150°C	TO-247	Tube	Pb Free

Electrical Characteristics (Tc =25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Collector-emitter breakdown voltage	BV_{CES}	$I_C = 1\text{mA}, V_{GE} = 0\text{V}$	1200	-	-	V
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 1\text{mA}$	4.5	5.5	6.5	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}$	-	-	1	mA
Gate-emitter leakage current	I_{GES}	$V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$	-	-	±250	nA
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 40\text{A}, V_{GE} = 15\text{V}, T_C = 25^\circ\text{C}$	-	2.0	2.4	V
		$I_C = 40\text{A}, V_{GE} = 15\text{V}, T_C = 150^\circ\text{C}$	-	2.45	-	
Dynamic and Switching Characteristics						
Total gate charge	Q_g	$V_{CE} = 600\text{V}, I_C = 40\text{A}, V_{GE} = 15\text{V}$	-	341	-	nC
Gate-emitter charge	Q_{ge}		-	52	-	
Gate-collector charge	Q_{gc}		-	126	-	
Input capacitance	C_{ies}	$V_{CE} = 30\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	-	6030	-	pF
Reverse transfer capacitance	C_{res}		-	107	-	
Output capacitance	C_{oes}		-	206	-	
Turn-on delay time	$t_{d(on)}$	$V_{GE} = 15\text{V}, V_{CC} = 600\text{V}, I_C = 40\text{A}, R_G = 10\Omega$ Inductive Load, $T_C = 25^\circ\text{C}$	-	65	-	ns
Rise time	t_r		-	55	-	
Turn-off delay time	$t_{d(off)}$		-	308	-	
Fall time	t_f		-	40	-	mJ
Turn-on switching energy	E_{on}		-	1.96	-	
Turn-off switching energy	E_{off}		-	0.54	-	
Total switching energy	E_{ts}	-	2.50	-		
Turn-on delay time	$t_{d(on)}$	$V_{GE} = 15\text{V}, V_{CC} = 600\text{V}, I_C = 40\text{A}, R_G = 10\Omega$ Inductive Load, $T_C = 150^\circ\text{C}$	-	70	-	ns
Rise time	t_r		-	62	-	
Turn-off delay time	$t_{d(off)}$		-	325	-	
Fall time	t_f		-	62	-	mJ
Turn-on switching energy	E_{on}		-	2.35	-	
Turn-off switching energy	E_{off}		-	1.61	-	
Total switching energy	E_{ts}	-	3.96	-		

Diode Characteristics (Tc =25°C unless otherwise specified)

Forward voltage	V_F	$I_F = 40\text{A}, T_C = 25^\circ\text{C}$	-	2.4	3.0	V
		$I_F = 40\text{A}, T_C = 150^\circ\text{C}$	-	2.45	-	
Reverse recovery time	t_{rr}	$I_F = 40\text{A}, di/dt = 200\text{A}/\mu\text{s}, T_C = 25^\circ\text{C}$	-	100	-	ns
Reverse recovery current	I_{rr}		-	7	-	A
Reverse recovery charge	Q_{rr}		-	350	-	nC
Reverse recovery time	t_{rr}	$I_F = 40\text{A}, di/dt = 200\text{A}/\mu\text{s}, T_C = 150^\circ\text{C}$	-	180	-	ns
Reverse recovery current	I_{rr}		-	10	-	A
Reverse recovery charge	Q_{rr}		-	900	-	nC

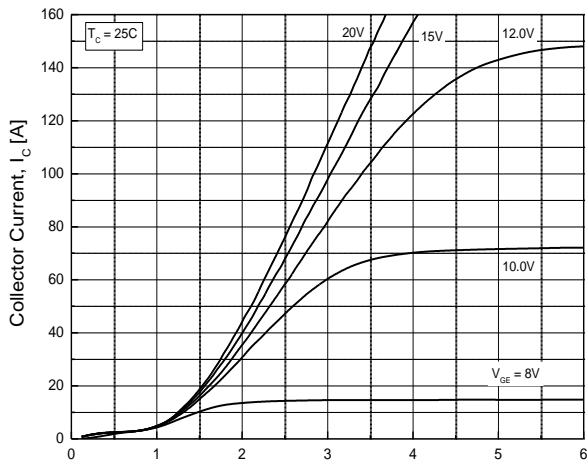


Fig.1 Typical Output Characteristics

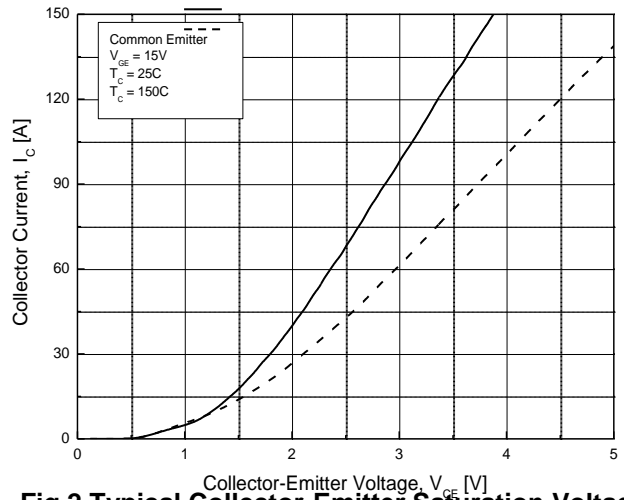


Fig.2 Typical Collector-Emitter Saturation Voltage

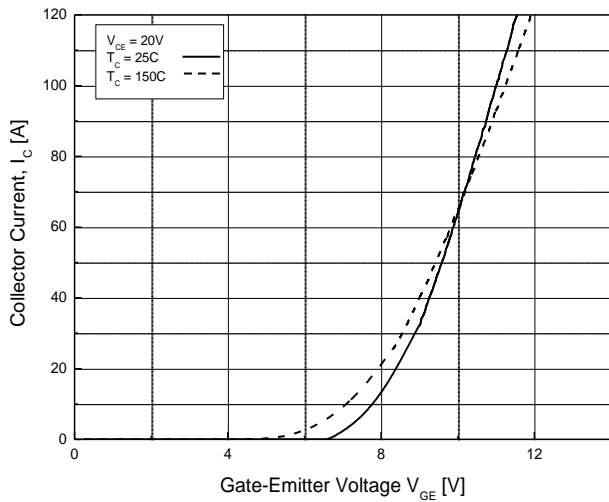


Fig.3 Typical Transfer Characteristics

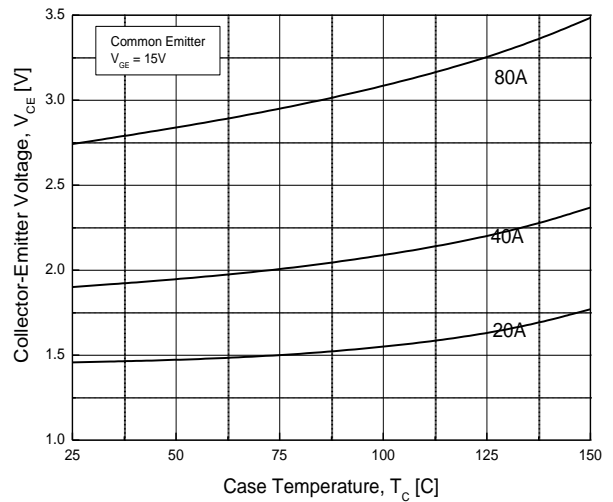


Fig.4 Typical Collector-Emitter Saturation Voltage at Case Temperature

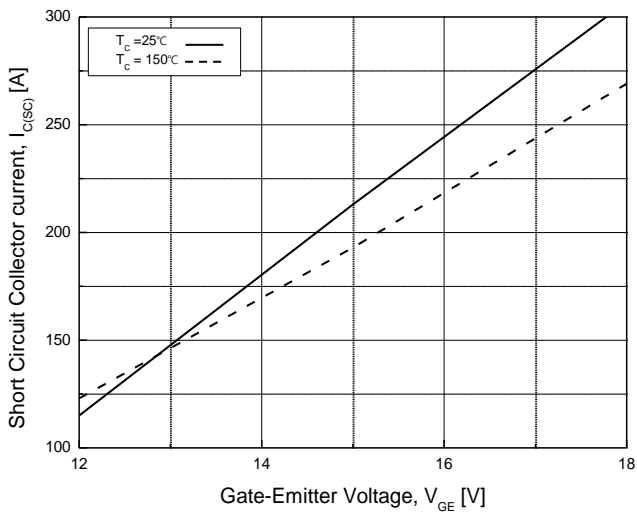


Fig.5 Typical Short Circuit Collector Current

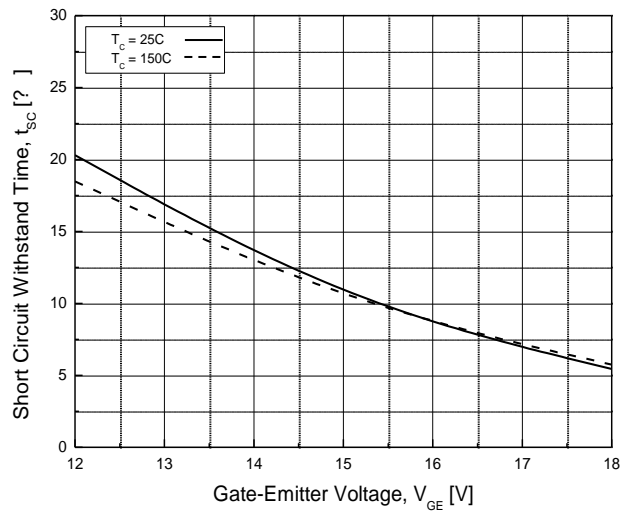


Fig.6 Typical Short Circuit Withstand Time

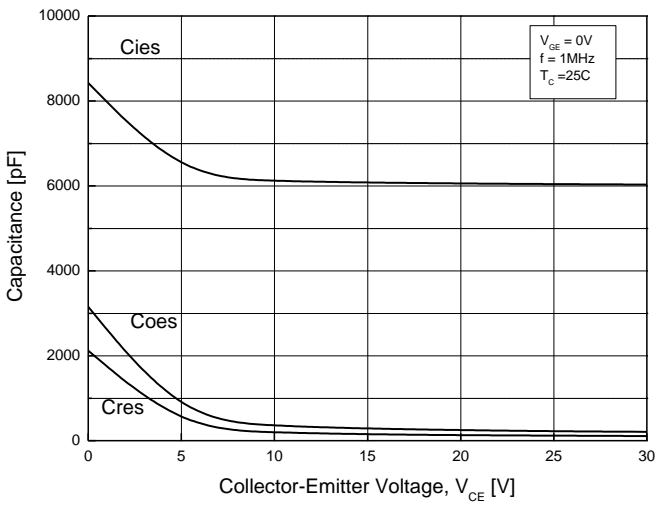


Fig.7 Typical Capacitance

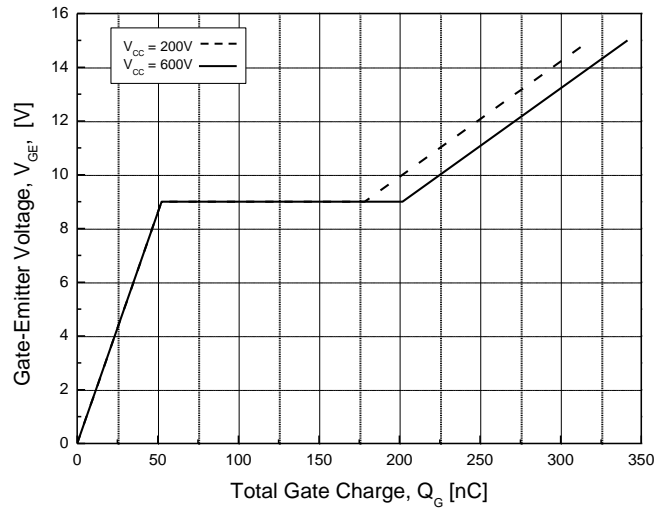


Fig.8 Typical Gate Charge

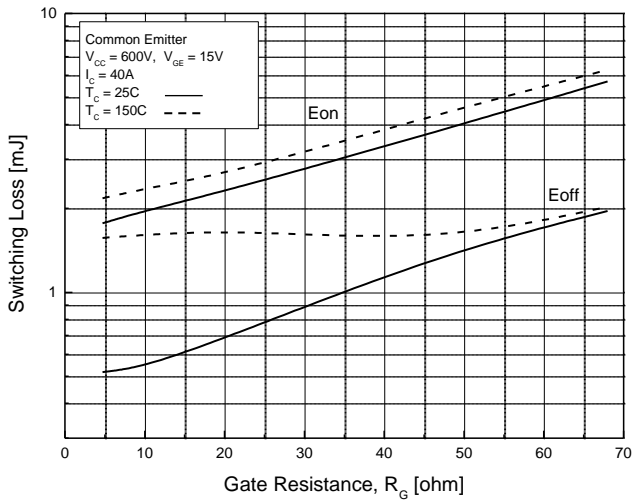


Fig.9 Switching Loss-Gate Resistance

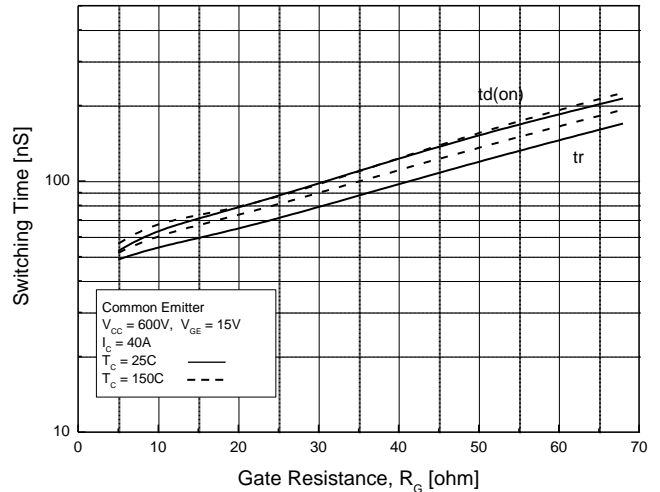


Fig.10 Turn on Characteristics-Gate Resistance

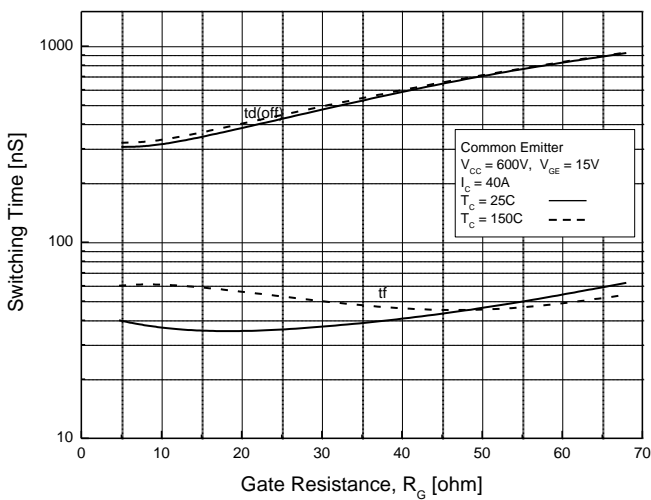


Fig.11 Turn off Characteristics-Gate Resistance

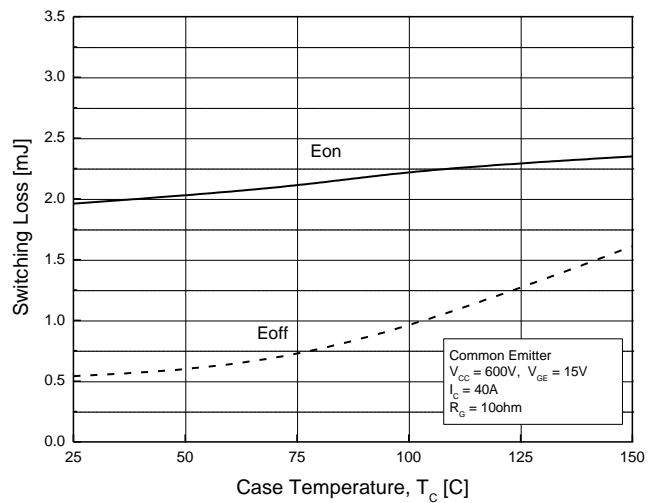


Fig.12 Switching Loss-Case Temperature

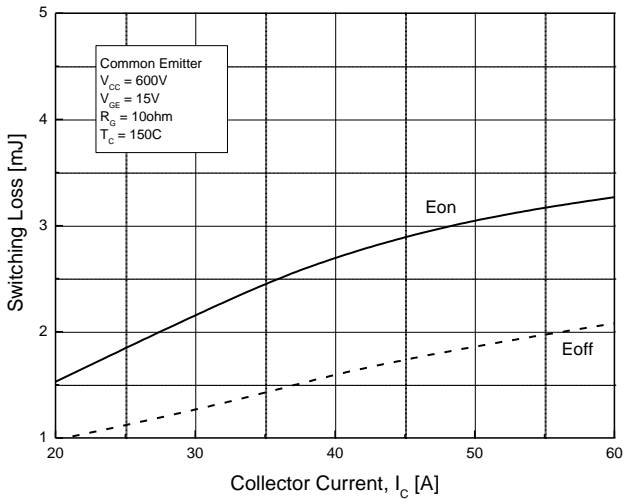


Fig.13 Switching Loss-Collector Current

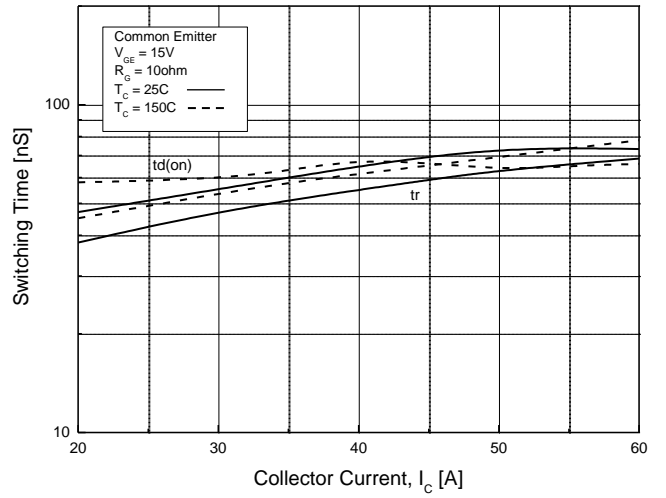


Fig.14 Typical Turn on-Collector Current

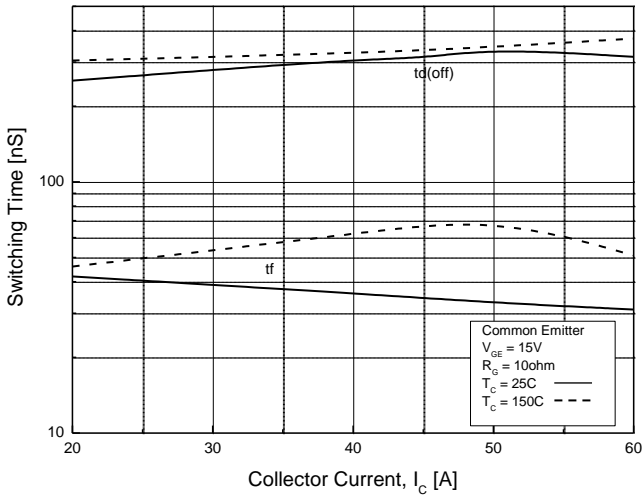


Fig.15 Typical Turn off-Collector Current

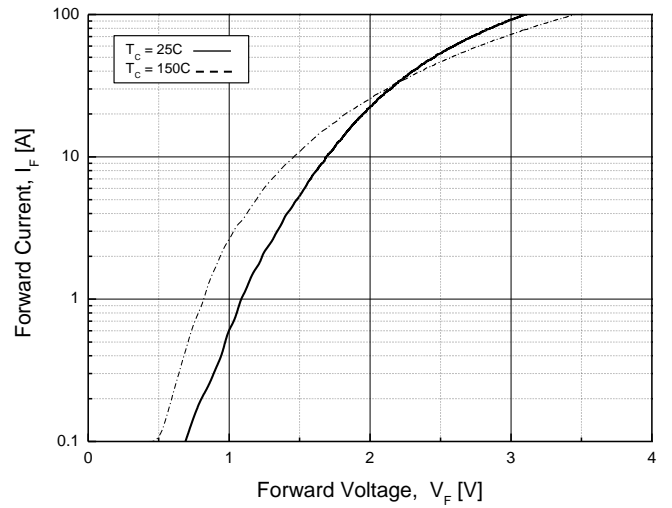


Fig.16 Diode Forward Characteristics

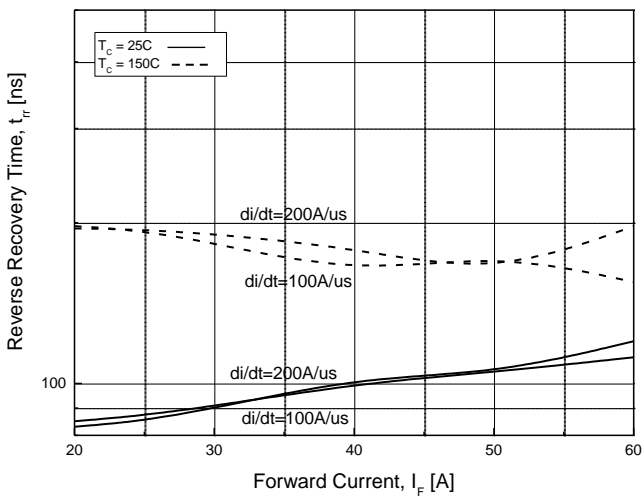


Fig.17 Typical Turn off-Collector Current

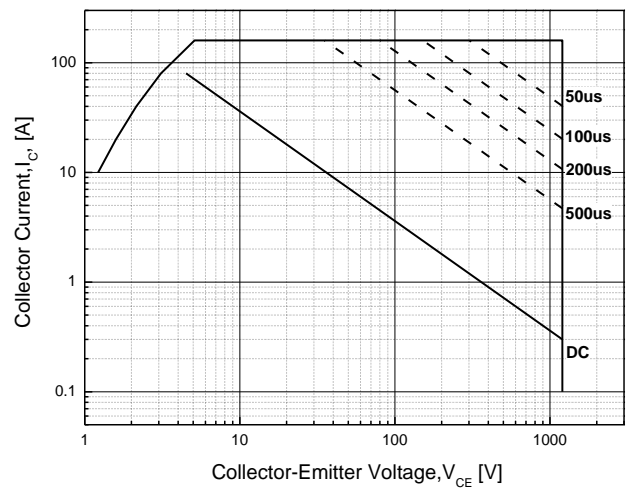


Fig.18 Forward Bias Safe Operating Area

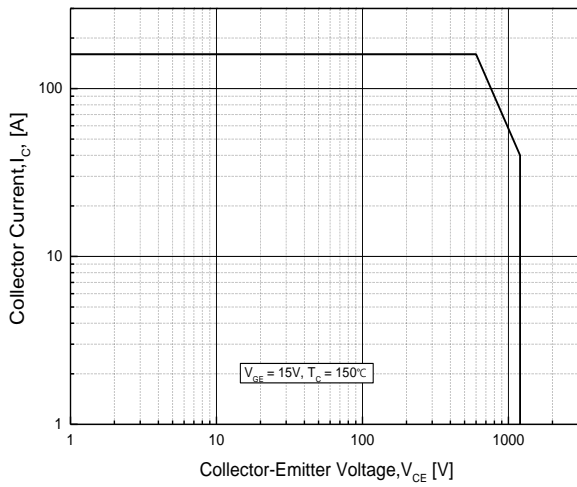


Fig.19 Reverse Bias Safe Operating Area

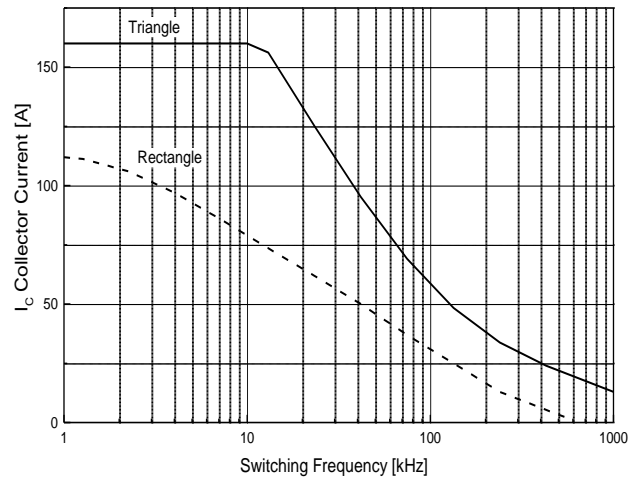


Fig.20 Switching frequency – Collector current

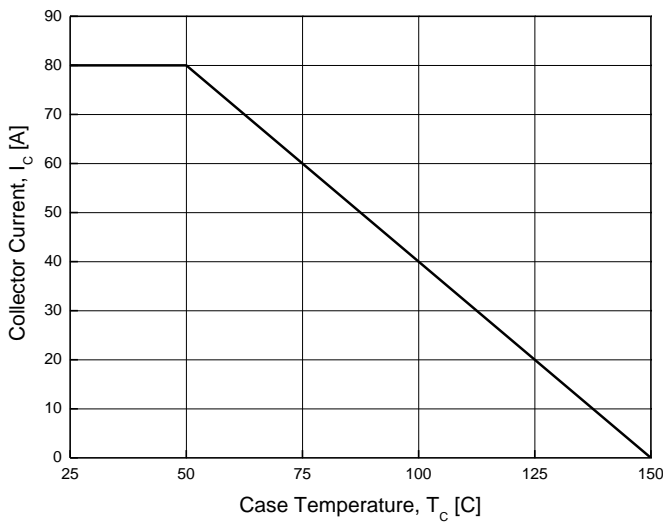


Fig.21 Case Temperature – Collector Current

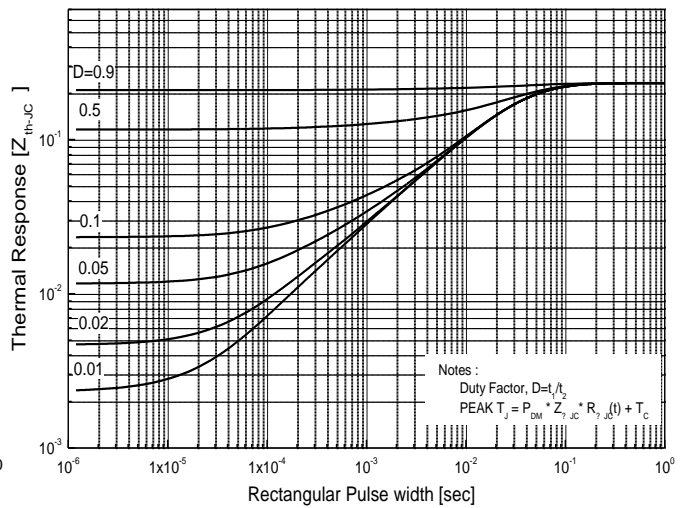
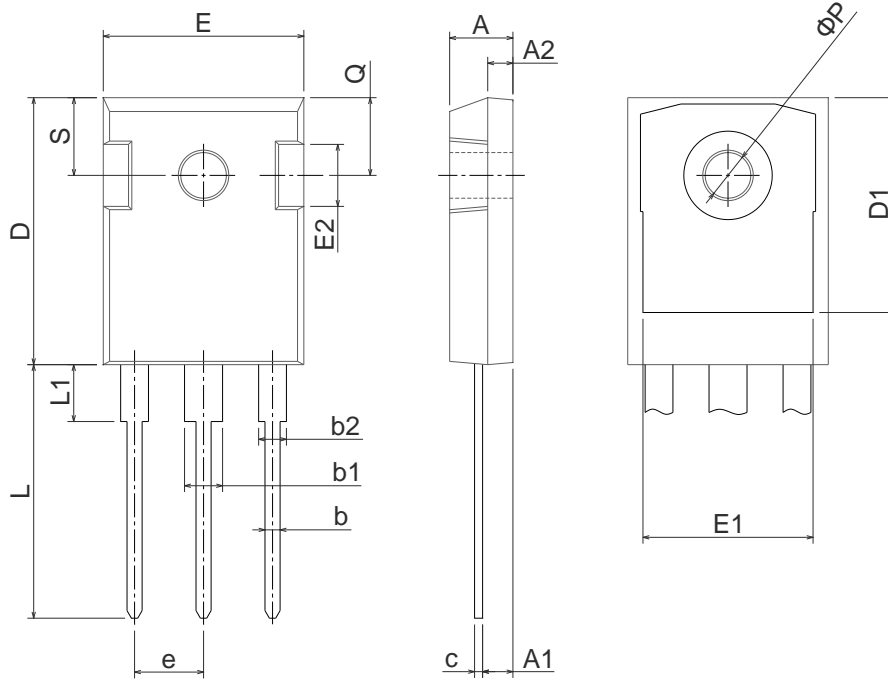


Fig.22 IGBT Transient Thermal Impedance

Physical Dimension

TO-247

Dimensions are in millimeters, unless otherwise specified




Dimension	Min(mm)	Max(mm)
A	4.70	5.31
A1	2.20	2.60
A2	1.50	2.49
b	0.99	1.40
b1	2.59	3.43
b2	1.65	2.39
c	0.38	0.89
D	20.30	21.46
D1	13.08	-
E	15.45	16.26
E1	13.06	14.02
E2	4.32	5.49
e	5.45BSC	
L	19.81	20.57
L1	-	4.50
ΦP	3.50	3.70
Q	5.38	6.20
S	6.15BSC	

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

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[AOB10B65M1](#) [CRG15T60A83L](#) [CRG40T120BK3SD](#) [CRG40T65AN5H](#) [SGT25U120FD1P7](#) [SGT20T60SDM1P7](#) [IHW15N120E1](#)
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